

NP180N055TUJ

R07DS0181EJ0100 Rev.1.00 Dec 22, 2010

Description

The NP180N055TUJ is N-channel MOS Field Effect Transistor designed for high current switching applications.

Features

- Low on-state resistance
 - -- R_{DS(on)} = 2.3 m Ω MAX. (V_{GS} = 10 V, I_D = 90 A)
- Low Ciss: Ciss = 9500 pF TYP. $(V_{DS} = 25 V)$
- Designed for automotive application and AEC-Q101 qualified

Ordering Information

Part No.	Lead Plating	Packing	Package
NP180N055TUJ-E1-AY *1	Pure Sn (Tin)	Tape 800 p/reel	TO-263-7pin, Taping (E1 type)
NP180N055TUJ-E2-AY *1			TO-263-7pin, Taping (E2 type)

Note: *1. Pb-free (This product does not contain Pb in the external electrode.)

Absolute Maximum Ratings ($T_A = 25^{\circ}C$)

Item	Symbol	Ratings	Unit
Drain to Source Voltage (V_{GS} = 0 V)	V _{DSS}	55	V
Gate to Source Voltage (V _{DS} = 0 V)	V _{GSS}	±20	V
Drain Current (DC) (T _C = 25°C)	I _{D(DC)}	±180	А
Drain Current (pulse) *1	I _{D(pulse)}	±720	А
Total Power Dissipation ($T_C = 25^{\circ}C$)	P _{T1}	348	W
Total Power Dissipation ($T_A = 25^{\circ}C$) *2	P _{T2}	1.8	W
Channel Temperature	T _{ch}	175	°C
Storage Temperature	T _{stg}	–55 to +175	°C
Repetitive Avalanche Current *3	I _{AR}	66	А
Repetitive Avalanche Energy *3	E _{AR}	435	mJ

Thermal Resistance

Channel to Case Thermal Resistance	R _{th(ch-C)}	0.43	°C/W
Channel to Ambient Thermal Resistance *2	R _{th(ch-A)}	83.3	°C/W

Notes: *1. T_C = 25°C, PW \leq 10 μ s, Duty Cycle \leq 1%

*2. Mounted on glass epoxy substrate of 40 mm x 40 mm x 0.8 mmt

*3. $T_{ch(peak)} \leq 150^{\circ}C$, $R_G = 25 \Omega$



Electrical Characteristics (T_A = 25°C)

Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Zero Gate Voltage Drain Current	I _{DSS}			1	μA	V _{DS} = 55 V, V _{GS} = 0 V
Gate Leakage Current	I _{GSS}			±100	nA	V_{GS} = ±20 V, V_{DS} = 0 V
Gate to Source Threshold Voltage	V _{GS(th)}	2.0	3.0	4.0	V	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$
Forward Transfer Admittance *1	y _{fs}	65	130		S	V _{DS} = 5 V, I _D = 90 A
Drain to Source On-state Resistance ^{*1}	R _{DS(on)}		1.7	2.3	mΩ	V _{GS} = 10 V, I _D = 90 A
Input Capacitance	Ciss		9500	14250	pF	V _{DS} = 25 V,
Output Capacitance	Coss		1060	1590	pF	V _{GS} = 0 V,
Reverse Transfer Capacitance	C _{rss}		320	580	pF	f = 1 MHz
Turn-on Delay Time	t _{d(on)}		45	100	ns	V _{DD} = 28 V, I _D = 90 A,
Rise Time	t _r		20	50	ns	V _{GS} = 10 V,
Turn-off Delay Time	t _{d(off)}		100	200	ns	R _G = 0 Ω
Fall Time	t _f		10	30	ns	
Total Gate Charge	Q _G		150	230	nC	V _{DD} = 44 V,
Gate to Source Charge	Q _{GS}		35		nC	V _{GS} = 10 V,
Gate to Drain Charge	Q _{GD}		45		nC	I _D = 180 A
Body Diode Forward Voltage *1	V _{F(S-D)}		0.9	1.5	V	I _F = 180 A, V _{GS} = 0 V
Reverse Recovery Time	t _{rr}		64		ns	I _F = 180 A, V _{GS} = 0 V,
Reverse Recovery Charge	Q _{rr}		138		nC	di/dt = 100 A/µs

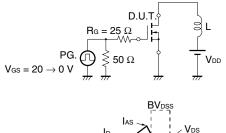
PG.

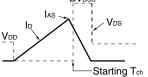
Vgs

0-

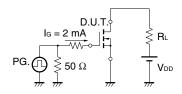
Note: *1. Pulsed

TEST CIRCUIT 1 AVALANCHE CAPABILITY

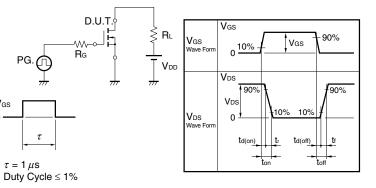




TEST CIRCUIT 3 GATE CHARGE



TEST CIRCUIT 2 SWITCHING TIME

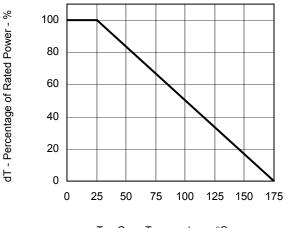




I_D - Drain Current - A

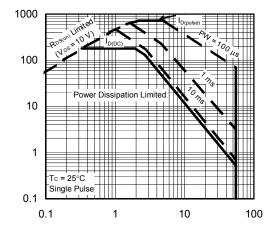
Typical Characteristics ($T_A = 25^{\circ}C$)

DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA

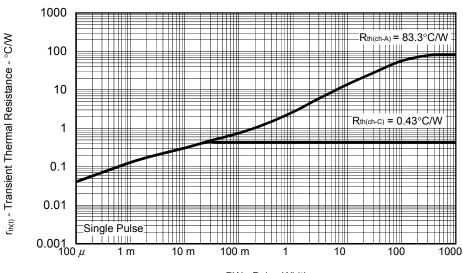


 T_C - Case Temperature - $^\circ C$

FORWARD BIAS SAFE OPERATING AREA



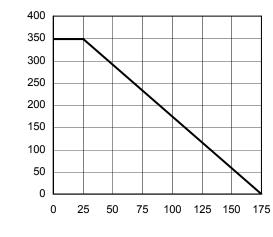
 V_{DS} - Drain to Source Voltage - V



TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

 $P_{\rm T}$ - Total Power Dissipation - W

PW - Pulse Width - s

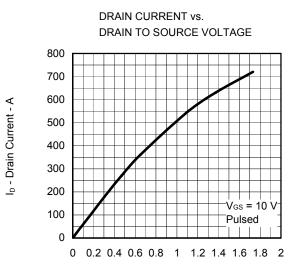


TOTAL POWER DISSIPATION vs.

CASE TEMPERATURE

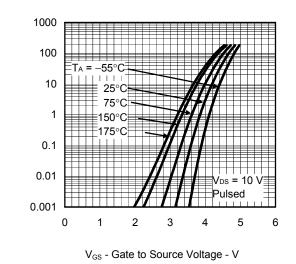
T_c - Case Temperature - °C





V_{DS} - Drain to Source Voltage - V

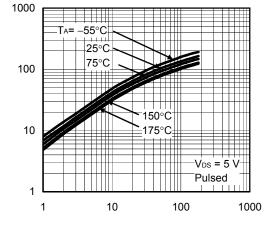
FORWARD TRANSFER CHARACTERISTICS

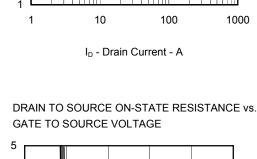


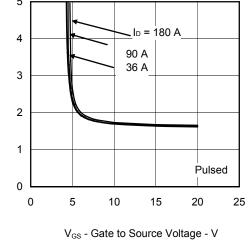
I_D - Drain Current - A

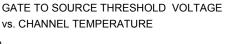
y_{fs} | - Forward Transfer Admittance - S

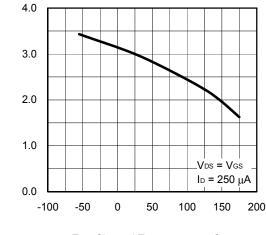
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT

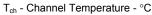




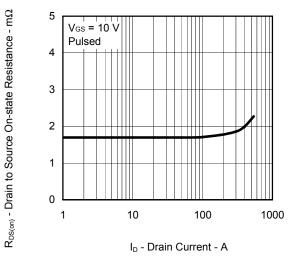








DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT





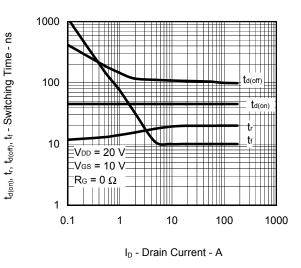
 $R_{\text{DS(on)}}$ - Drain to Source On-state Resistance - $m\Omega$

 $R_{\text{DS(on)}}$ - Drain to Source On-state Resistance - $m\Omega$ 5.0 Vgs = 10 V . I⊳ = 90 A 4.0 3.0 2.0 1.0 Pulsed 0.0 -100 -50 0 50 100 150 200 T_{ch} - Channel Temperature - °C

DRAIN TO SOURCE ON-STATE RESISTANCE vs.

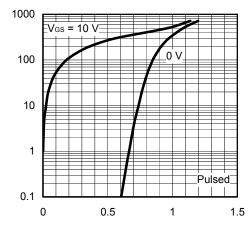
CHANNEL TEMPERATURE

SWITCHING CHARACTERISTICS



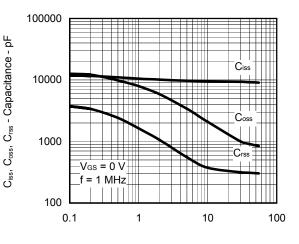
SOURCE TO DRAIN DIODE FORWARD VOLTAGE





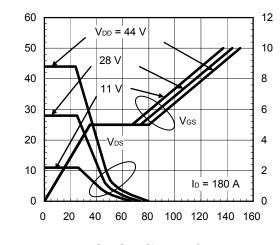
 $V_{\text{F(S-D)}}$ - Source to Drain Voltage - V

CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



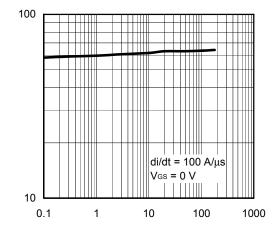


DYNAMIC INPUT/OUTPUT CHARACTERISTICS



Q_G - Gate Charge - nC

REVERSE RECOVERY TIME vs. DRAIN CURRENT



IF - Drain Current - A

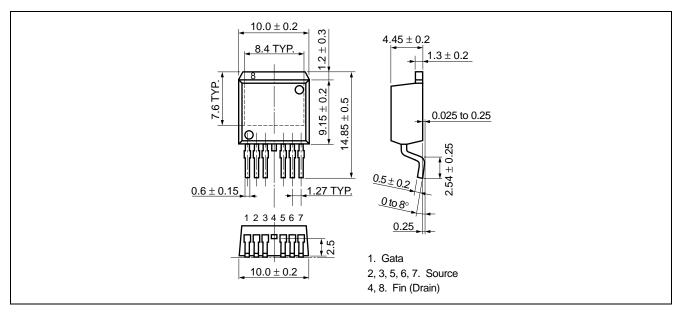


V_{DS} - Drain to Source Voltage - V

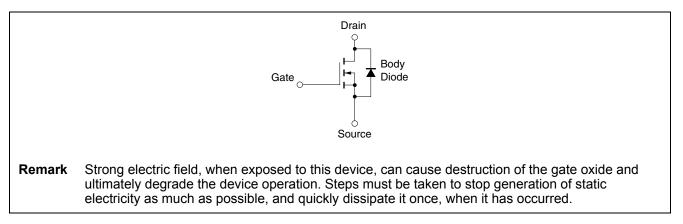
t_{rr} - Reverse Recovery Time - ns

Package Drawings (Unit: mm)

TO-263-7pin (MP-25ZT) (Mass: 1.5 g TYP.)



Equivalent Circuit





NP180N055TUJ Data Sheet

		Description				
Rev.	Date	Page	ge Summary			
1.00	Dec 22, 2010	-	First Edition Issued			

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